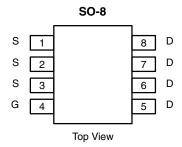


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# N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) (Max.)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
30	0.0034 at V <sub>GS</sub> = 10 V	31.3	22.5 nC			
	0.0044 at V <sub>GS</sub> = 4.5 V	27.5				



#### Ordering Information:

Si4010DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

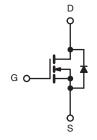
#### **FEATURES**

- TrenchFET® Power MOSFET
- $\bullet$  100 %  $R_{\rm g}$  and UIS Tested
- Material categorization:
  For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>



## **APPLICATIONS**

- Synchronous Rectification
- DC/DC Conversion
- Telecom/Server
- Industrial



N-Channel MOSFET

Parameter	Symbol	Symbol Limit			
Drain-Source Voltage		V <sub>DS</sub>	30		
Gate-Source Voltage		V <sub>GS</sub>	+ 20, - 16	V	
-	T <sub>C</sub> = 25 °C		31.3		
Continues Durin Comment /T. 150 °C)	T <sub>C</sub> = 70 °C	1 .	24.9		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	20.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		16.1 <sup>b, c</sup>		
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	100	A	
	T <sub>C</sub> = 25 °C		5.4		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	2.2 <sup>b, c</sup>		
Single Pulse Avalanche Current	1 0411	I <sub>AS</sub>	20		
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		6		
Marian and David Discipation	T <sub>C</sub> = 70 °C		3.8	14/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	$R_{thJA}$	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	17	21	C/VV		

### Notes

- a. Based on  $T_C = 25$  °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. Maximum under steady state conditions is 85 °C/W.



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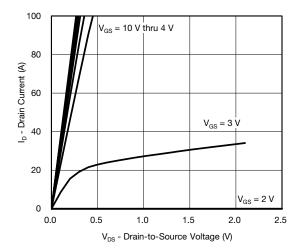
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	AVne/Tu		14		m) 1/96	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	- I <sub>D</sub> = 250 μA		- 5.5		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1		2.3	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = + 20 V, - 16 V			± 100	nA	
Zawa Oata Waltana Duain Ouwant		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1	μA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	°C		10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
Durin On the Order Business		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A			0.0034	1	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.0035	0.0044	Ω	
Forward Transconductancea	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		105		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			3595		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1040			
Reverse Transfer Capacitance	C <sub>rss</sub>	]		79			
Tatal Cata Chausa	0	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		51	77	77 34 nC	
Total Gate Charge	Q <sub>g</sub>			22.5	34		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		8.6			
Gate-Drain Charge	Q <sub>gd</sub>			4			
Output Charge	Q <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V		30.5			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.5	1.25	2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			24	48		
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$		17	34		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong 10$ A, $V_{GEN}=4.5$ V, $R_g=1$ $\Omega$		25	50		
Fall Time	t <sub>f</sub>			12	24		
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		10	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ Å}, V_{GEN} = 1.5 \text{ V}, R_g = 1 \Omega$		30	60		
Fall Time	t <sub>f</sub>			9	18		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			5.4	Α	
Pulse Diode Forward Current	I <sub>SM</sub>				100	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 5 A,		0.73	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			36	70	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	]   10 A dl/dt 100 A/::- T 05 00		24	48	nC	
Reverse Recovery Fall Time	ta	- I <sub>F</sub> = 10 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C		16		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	1		20			

### Notes

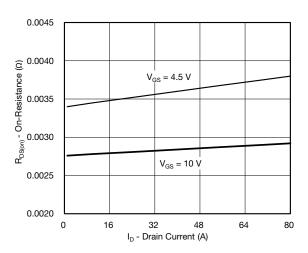
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

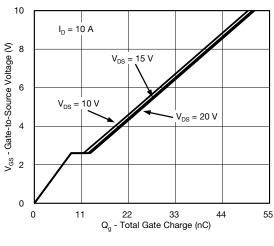




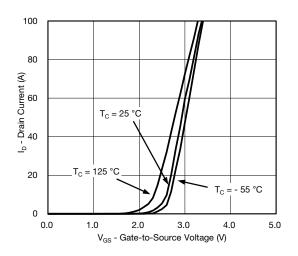
### **Output Characteristics**



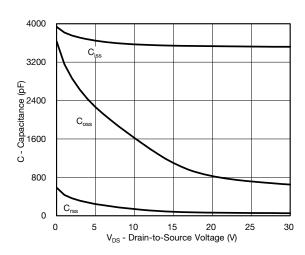
On-Resistance vs. Drain Current



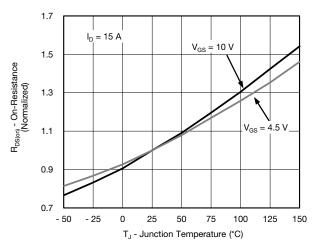
**Gate Charge** 



**Transfer Characteristics** 

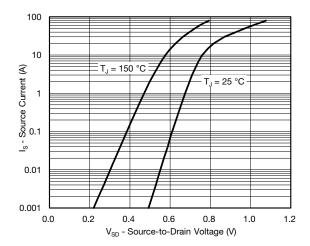


Capacitance

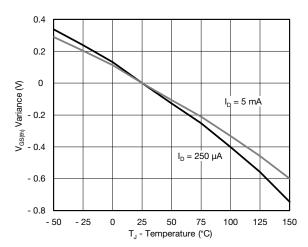


On-Resistance vs. Junction Temperature

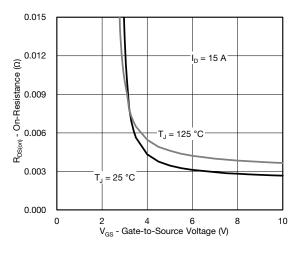




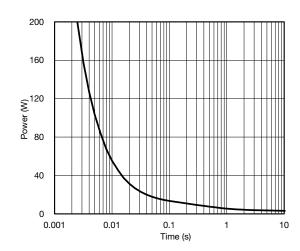
### Source-Drain Diode Forward Voltage



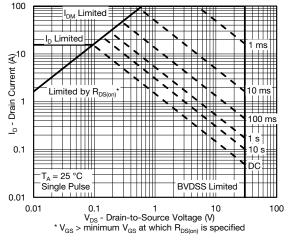
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

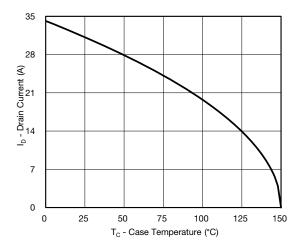


Single Pulse Power, Junction-to-Ambient

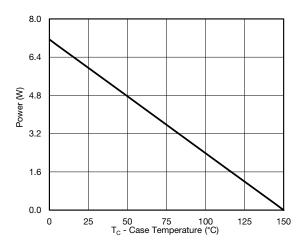


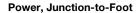
Safe Operating Area, Junction-to-Ambient

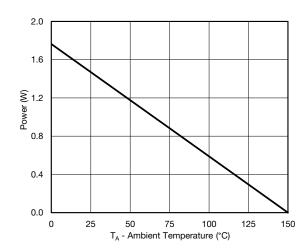




### **Current Derating\***



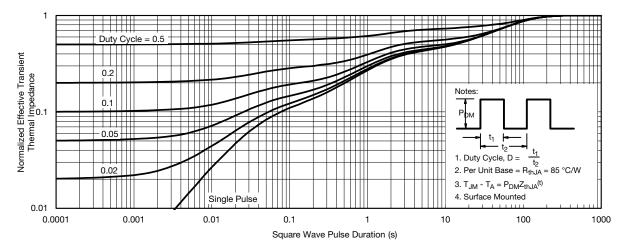




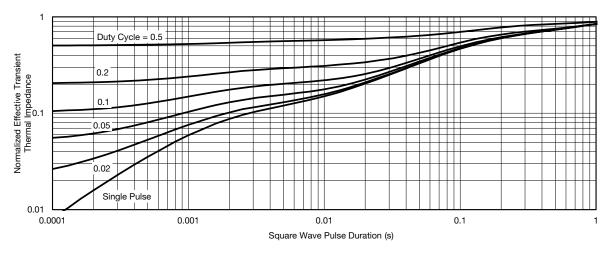
Power, Junction-to-Ambient

<sup>\*</sup> The power dissipation P<sub>D</sub> is based on T<sub>J(max.)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





#### Normalized Thermal Transient Impedance, Junction-to-Ambient



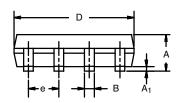
Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050	0.050 BSC	
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Bev   11-Sen-06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06 www.vishay.com



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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